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# FDP8880 / FDB8880

May 2008

FAIRCHILD

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## FDP8880 / FDB8880 N-Channel PowerTrench<sup>®</sup> MOSFET 30V, 54A, 11.6mΩ

## **Features**

- $r_{DS(ON)} = 14.5m\Omega$ ,  $V_{GS} = 4.5V$ ,  $I_D = 40A$
- r<sub>DS(ON)</sub> = 11.6mΩ, V<sub>GS</sub> = 10V, I<sub>D</sub> = 40A
- High performance trench technology for extremely low <sup>r</sup>DS(ON)
- Low gate charge
- High power and current handling capability
- RoHS Complicant

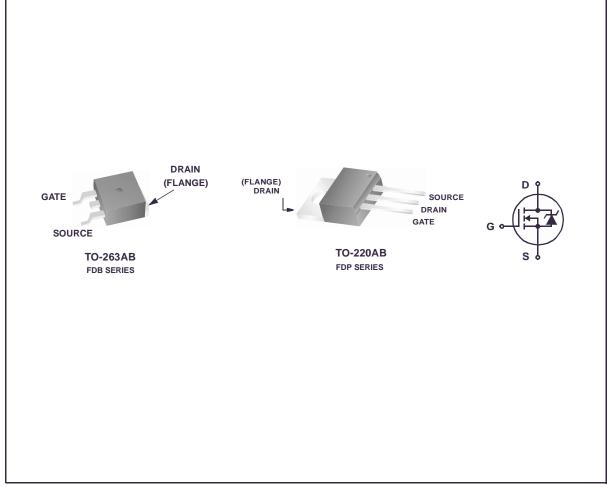


## **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{\text{DS}(\text{ON})}$  and fast switching speed.

## Application

DC / DC Converters



Symbol	Parameter	Ratings	Units
V <sub>DSS</sub>	Drain to Source Voltage	30	V
V <sub>GS</sub>	Gate to Source Voltage	±20	V
I <sub>D</sub>	Drain Current		
	Continuous ( $T_C = 25^{\circ}C$ , $V_{GS} = 10V$ )	54	A
	Continuous ( $T_C = 25^{\circ}C$ , $V_{GS} = 4.5V$ )	48	A
	Continuous ( $T_{amb} = 25^{\circ}C$ , $V_{GS} = 10V$ , with $R_{\theta JA} = 43^{\circ}C/W$ )	11	A
	Pulsed	Figure 4	A
- AS	Single Pulse Avalanche Energy (Note 1)	31	mJ
	Power dissipation	55	W
D	Derate above 25°C	0.37	W/ºC
J, T <sub>STG</sub>	Operating and Storage Temperature	-55 to 175	°C

## **Thermal Characteristics**

$R_{ extsf{ heta}JC}$	Thermal Resistance Junction to Case TO-220, TO-263	2.73	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient TO-220, TO-262 (Note 2)	62	°C/W
$R_{ hetaJA}$	Thermal Resistance Junction to Ambient TO-263, 1in <sup>2</sup> copper pad area	43	°C/W

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDP8880	FDP8880	TO-220AB	Tube	N/A	50 units
FDB8880	FDB8880	TO-263AB	330mm	24mm	800 units

## **Electrical Characteristics** $T_{C} = 25^{\circ}C$ unless otherwise noted

DSS Zero Gate Voltage Drain Current	ge $I_D = 250\mu A, V_{GS} = 0V$ $V_{DS} = 24V$ $V_{GS} = 0V$ $T_C = 150^{\circ}C$ $V_{GS} = \pm 20V$	30 - -		- 1 250	V µA
DSS Zero Gate Voltage Drain Current	$V_{DS} = 24V$ $V_{GS} = 0V$ $T_{C} = 150^{\circ}C$	-	-	1	
I <sub>DSS</sub> Zero Gate Voltage Drain Current	$V_{GS} = 0V \qquad T_C = 150^{\circ}C$				uА
		-	-	250	μΛ
I <sub>GSS</sub> Gate to Source Leakage Current	$1/2 = \pm 201/$		1	230	1
	$v_{GS} = \pm 20 v$	-	-	±100	nA
On Characteristics					
V <sub>GS(TH)</sub> Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	1.2	-	2.5	V
	$I_{D} = 40A, V_{GS} = 10V$	-	0.0095	0.0116	Ω
r <sub>DS(ON)</sub> Drain to Source On Resistance	$I_{D} = 40A, V_{GS} = 4.5V$	-	0.012	0.0145	
	$I_D = 40A, V_{GS} = 10V,$ $T_J = 175^{\circ}C$	-	0.015	0.019	

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Dynamic	Characteristics					
C <sub>ISS</sub>	Input Capacitance		-	1240	-	pF
C <sub>OSS</sub>	Output Capacitance	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1MHz	-	255	-	pF
C <sub>RSS</sub>	Reverse Transfer Capacitance			147	-	pF
R <sub>G</sub>	Gate Resistance	$V_{GS} = 0.5V, f = 1MHz$	-	2.7	-	Ω
Q <sub>g(TOT)</sub>	Total Gate Charge at 10V	$V_{GS} = 0V$ to 10V	-	22	29	nC
Q <sub>g(5)</sub>	Total Gate Charge at 5V	$V_{GS} = 0V \text{ to } 5V$	-	12	16	nC
Q <sub>g(TH)</sub>	Threshold Gate Charge	$V_{GS} = 0V \text{ to } 1V$ $V_{DD} = 15V$ $I_D = 40A$	-	1.6	2.1	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	$I_D = 40A$ $I_a = 1.0mA$	-	3.2	-	nC
Q <sub>gs2</sub>	Gate Charge Threshold to Plateau		-	2.0	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		-	4.8	-	nC

## Switching Characteristics ( $V_{GS} = 10V$ )

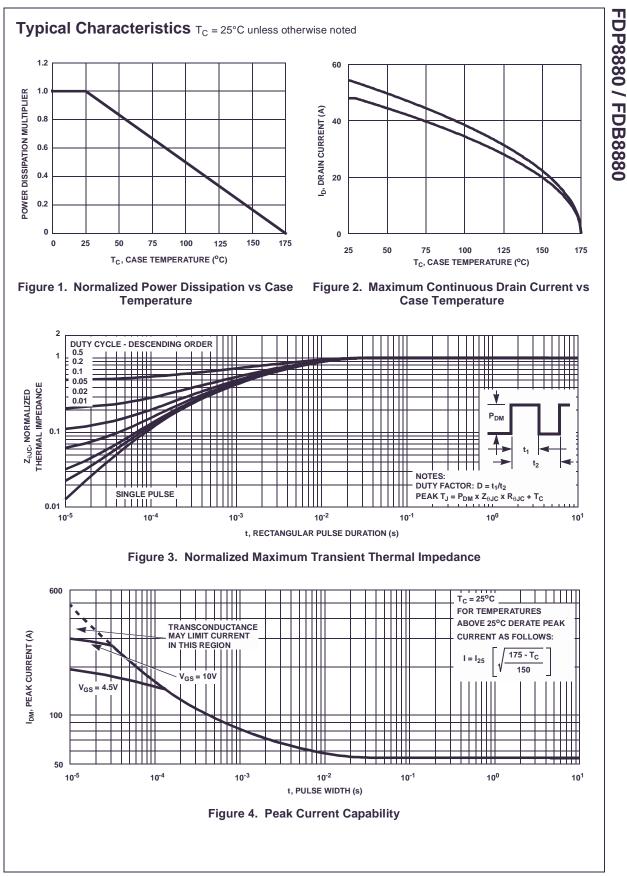
t <sub>ON</sub>	Turn-On Time		-	-	171	ns
t <sub>d(ON)</sub>	Turn-On Delay Time		-	8	-	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15V, I <sub>D</sub> = 40A	-	107	-	ns
t <sub>d(OFF)</sub>	Turn-Off Delay Time	$V_{GS} = 10V, R_{GS} = 13.6\Omega$	-	47	-	ns
t <sub>f</sub>	Fall Time		-	51	-	ns
t <sub>OFF</sub>	Turn-Off Time		-	-	147	ns

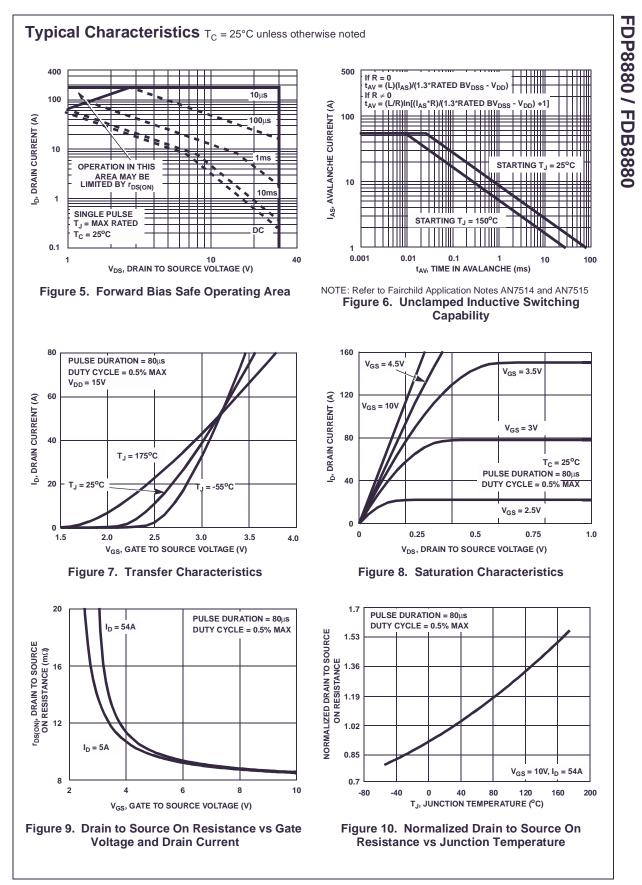
## **Drain-Source Diode Characteristics**

M.	Source to Drain Diode Voltage	I <sub>SD</sub> = 40A	-	-	1.25	V
V <sub>SD</sub>	Source to Drain Diode voltage	I <sub>SD</sub> = 3.5A	-	-	1.0	V
t <sub>rr</sub>	Reverse Recovery Time	$I_{SD} = 40A$ , $dI_{SD}/dt = 100A/\mu s$	-	-	27	ns
Q <sub>RR</sub>	Reverse Recovered Charge	$I_{SD} = 40A$ , $dI_{SD}/dt = 100A/\mu s$	-	-	18	nC

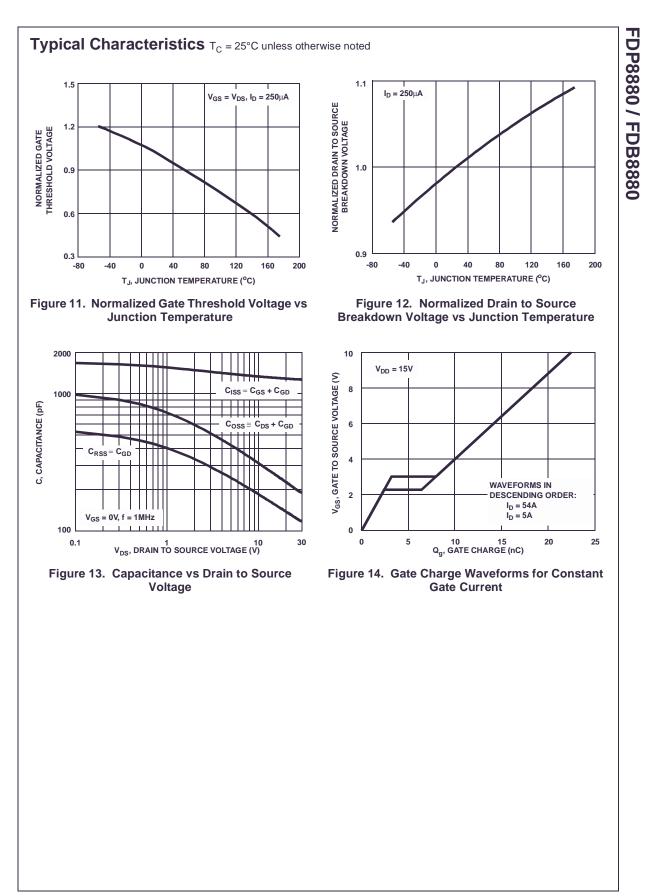
Notes: 1: Starting  $T_J = 25^{\circ}$ C, L = 34uH, I<sub>AS</sub> = 43A,Vdd = 27V, Vgs = 10V. 2: Pulse width = 100s.

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## FDP8880 / FDB8880 **Test Circuits and Waveforms** V<sub>DS</sub> BV<sub>DSS</sub> L. $V_{DS}$ VARY tP TO OBTAIN IAS $V_{DD}$ REQUIRED PEAK IAS R<sub>G</sub> li∢ VDD V<sub>GS</sub> DUT AS **0.01**Ω t<sub>AV</sub> -> Figure 15. Unclamped Energy Test Circuit Figure 16. Unclamped Energy Waveforms

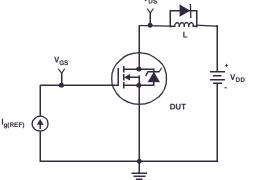


Figure 17. Gate Charge Test Circuit

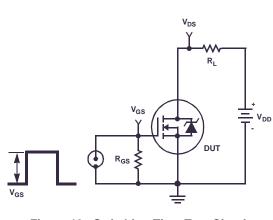
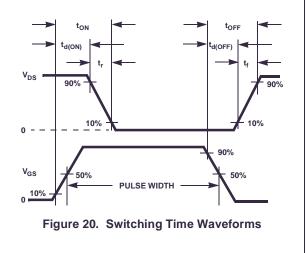
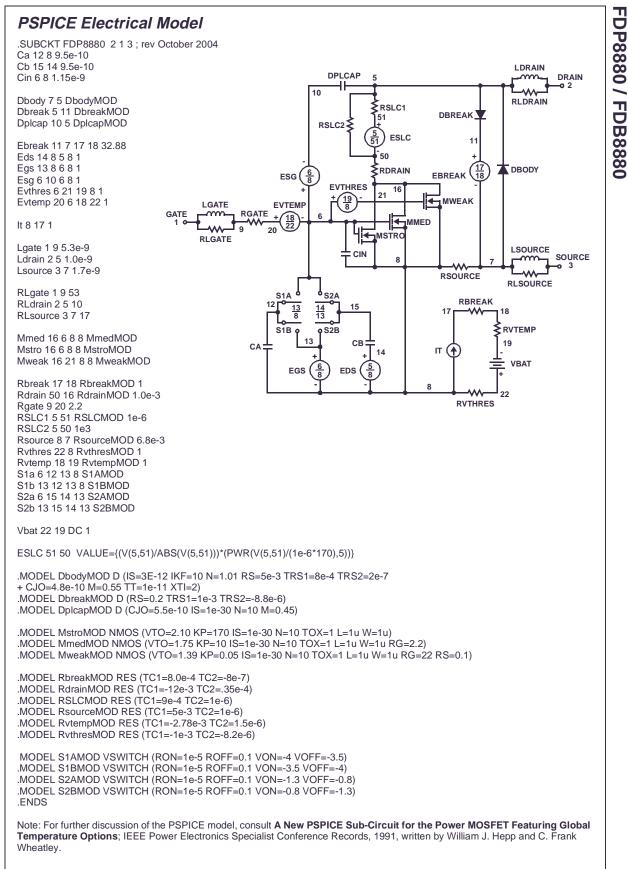


Figure 19. Switching Time Test Circuit

 $V_{DD}$   $V_{Qg(TOT)}$   $V_{GS} = 10V$   $V_{GS} = 1V$   $V_{GS} = 5V$   $V_{GS} = 1V$   $V_{GS} = 5V$  $V_{GS} = 1V$   $V_{GS} = 5V$ 

Figure 18. Gate Charge Waveforms





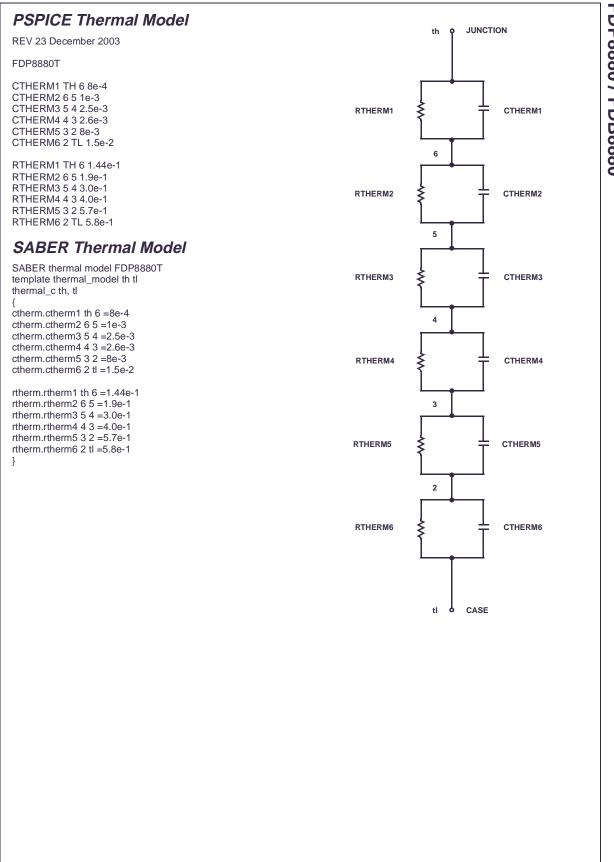
### SABER Electrical Model rev October 2004 template FDP8880 n2,n1,n3 electrical n2,n1,n3 var i iscl dp..model dbodymod = (isl=3e-12,ikf=10,nl=1.01,rs=5e-3,trs1=8e-4,trs2=2e-7,cjo=4.8e-10,m=0.55,tt=1e-11,xti=2) dp..model dbreakmod = (rs=0.2.trs1=1e-3.trs2=-8.8e-6)dp..model dplcapmod = (cjo=5.5e-10,isl=10e-30,nl=10,m=0.45) m..model mstrongmod = (type=\_n,vto=2.10,kp=170,is=1e-30, tox=1) m..model mmedmod = $(type=_n, vto=1.75, kp=10, is=1e-30, tox=1)$ m..model mweakmod = (type=\_n,vto=1.39,kp=0.05,is=1e-30, tox=1,rs=0.1) sw\_vcsp..model s1amod = (ron=1e-5,roff=0.1,von=-4,voff=-3.5) LDRAIN sw\_vcsp..model s1bmod = (ron=1e-5,roff=0.1,von=-3.5,voff=-4) DPLCAP DRAIN sw\_vcsp..model s2amod = (ron=1e-5,roff=0.1,von=-1.3,voff=-0.8) 10 \*\*\* sw\_vcsp..model s2bmod = (ron=1e-5,roff=0.1,von=-0.8,voff=-1.3) RLDRAIN c.ca n12 n8 = 9.5e-10RSLC1 c.cb n15 n14 = 9.5e-10 51 RSLC2 ₹ c.cin n6 n8 = 1.15e-9 ISCI dp.dbody n7 n5 = model=dbodymod DBREAK 50 dp.dbreak n5 n11 = model=dbreakmod RDRAIN <u>6</u> 8 dp.dplcap n10 n5 = model=dplcapmod ESG 11 DBODY EVTHRES 16 spe.ebreak n11 n7 n17 n18 = 32.88 (<u>19</u>) 8 MWEAK 4 LGATE EVTEMP spe.eds n14 n8 n5 n8 = 1 RGATE GATE $\mathcal{M}$ spe.egs n13 n8 n6 n8 = 1 18 22 EBREAK MMED 9 20 MSTRO spe.esg n6 n10 n6 n8 = 1 RLGATE spe.evthres n6 n21 n19 n8 = 1 I SOURCE CIN spe.evtemp n20 n6 n18 n22 = 1 SOURCE 8 • RSOURCE ~~~ i.it n8 n17 = 1 RLSOURCE S1 4 I.lgate n1 n9 = 5.3e-9 RBREAK <u>13</u> 8 <u>14</u> 13 I.Idrain n2 n5 = 1.0e-9 17 18 I.lsource n3 n7 = 1.7e-9 ≷RVTEMP S1B o S2B 13 СВ 19 res.rlgate n1 n9 = 53 СА ( IT 14 res.rldrain n2 n5 = 10 VBAT res.rlsource n3 n7 = 17 5 EGS EDS 8 m.mmed n16 n6 n8 n8 = model=mmedmod, l=1u, w=1u 22 m.mstrong n16 n6 n8 n8 = model=mstrongmod, l=1u, w=1u RVTHRES m.mweak n16 n21 n8 n8 = model=mweakmod, l=1u, w=1u res.rbreak n17 n18 = 1, tc1=8.0e-4,tc2=-8e-7 res.rdrain n50 n16 = 1.0e-3, tc1=-12e-3,tc2=.35e-4 res.rgate n9 n20 = 2.2 res.rslc1 n5 n51 = 1e-6, tc1=9e-4,tc2=1e-6 res.rslc2 n5 n50 = 1e3res.rsource n8 n7 = 6.8e-3, tc1=5e-3,tc2=1e-6 res.rvthres n22 n8 = 1, tc1=-1e-3,tc2=-8.2e-6 res.rvtemp n18 n19 = 1, tc1=-2.78e-3,tc2=1.5e-6 sw vcsp.s1a n6 n12 n13 n8 = model=s1amod sw\_vcsp.s1b n13 n12 n13 n8 = model=s1bmod sw\_vcsp.s2a n6 n15 n14 n13 = model=s2amod sw\_vcsp.s2b n13 n15 n14 n13 = model=s2bmod v.vbat n22 n19 = dc=1 equations {

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i (n51->n50) +=iscl

}

iscl: v(n51,n50) = ((v(n5,n51)/(1e-9+abs(v(n5,n51))))\*((abs(v(n5,n51)\*1e6/170))\*\* 5)))



# FDP8880 / FDB8880



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